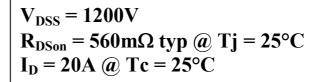
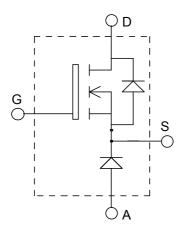


ISOTOP® Buck chopper MOSFET + SiC chopper diode Power module





Application

- AC and DC motor control
- Switched Mode Power Supplies

Features

Power MOS 8TM MOSFET

- Low R_{DSon}
- Low input and Miller capacitance
- Low gate charge
- Avalanche energy rated

• SiC Schottky Diode

- Zero reverse recovery
- Zero forward recovery
- Temperature Independent switching behavior
- Positive temperature coefficient on VF
- ISOTOP® Package (SOT-227)
- Very low stray inductance
- High level of integration

Benefits

- Outstanding performance at high frequency operation
- Stable temperature behavior
- Very rugged
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Easy paralleling due to positive TC of VCEsat
- **RoHS Compliant**



Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
$V_{ m DSS}$	Drain - Source Breakdown Voltage		1200	V
Ţ	Continuous Drain Current	$T_c = 25$ °C	20	
I_D		$T_c = 80$ °C	15	A
I_{DM}	Pulsed Drain current		104	
V_{GS}	Gate - Source Voltage		±30	V
R _{DSon}	Drain - Source ON Resistance		672	mΩ
P_D	Maximum Power Dissipation	$T_c = 25^{\circ}C$	543	W
I_{AR}	Avalanche current (repetitive and non repetitive)		14	A

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handing Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



All ratings @ $T_j = 25$ °C unless otherwise specified

Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 1200V$	$T_j = 25^{\circ}C$			100	^
		$V_{GS} = 0V$	$T_j = 125$ °C			500	μΑ
R _{DS(on)}	Drain – Source on Resistance	$V_{GS} = 10V, I_D = 14A$			560	672	mΩ
V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 2.5 \text{mA}$		3	4	5	V
I_{GSS}	Gate – Source Leakage Current	$V_{GS} = \pm 30 \text{ V}$	•			±100	nA

Dynamic Characteristics

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
C_{iss}	Input Capacitance	$V_{GS} = 0V$		7736		
C_{oss}	Output Capacitance	$V_{\rm DS} = 25V$		715		pF
C_{rss}	Reverse Transfer Capacitance	f = 1MHz		92		
Q_{g}	Total gate Charge	$V_{GS} = 10V$ $V_{Bus} = 600V$ $I_D = 14A$		300		nC
Q_{gs}	Gate – Source Charge			50		
Q_{gd}	Gate – Drain Charge			140		
$T_{d(on)}$	Turn-on Delay Time	Resistive switching @ 25°C $V_{GS} = 15V$ $V_{Bus} = 800V$ $I_D = 14A$ $R_G = 2.2\Omega$		50		
$T_{\rm r}$	Rise Time			31		
$T_{d(off)}$	Turn-off Delay Time			170		ns
$T_{\rm f}$	Fall Time			48		

SiC chopper diode ratings and characteristics

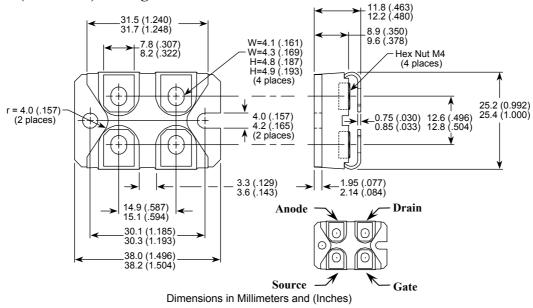
Symbol	Characteristic	Test Condition	Min	Тур	Max	Unit	
V_{RRM}	Maximum Peak Repetitive Reverse Voltage			1200			V
T	Maximum Reverse Leakage Current	1 \/ = 1 700\/	$T_j = 25^{\circ}C$		32	200	^
I_{RM}			$T_j = 175$ °C		56	1000	μΑ
I_F	DC Forward Current		Tc = 100°C		10		A
$V_{\rm F}$	Diode Forward Voltage	$I_{n} = I \cap \Delta$	$T_j = 25^{\circ}C$		1.6	1.8	V
v _F			$T_j = 175$ °C		2.3	3	v
Qc	Total Capacitive Charge	$I_F = 10A, V_R = 600V$ di/dt = $500A/\mu s$			80		nC
С	Total Capacitance	$f = 1MHz, V_R = 200V$			96		mE.
		$f = 1MHz, V_R =$	= 400V		69		pF

Thermal and package characteristics

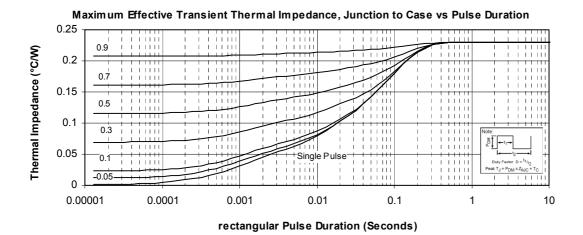
0.23	
4 6 7	
1.65	°C/W
20	
	V
150	°C
300	
1.5	N.m
	g
	20 150 300



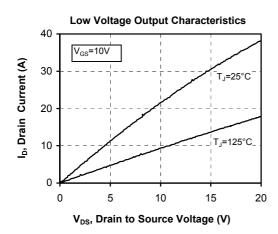
SOT-227 (ISOTOP®) Package Outline

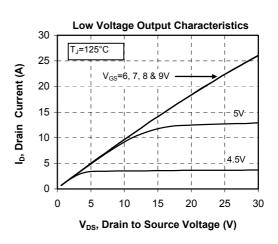


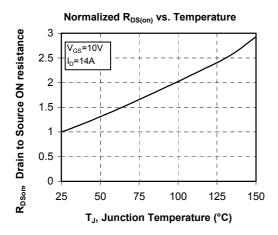
Typical Mosfet Performance Curve

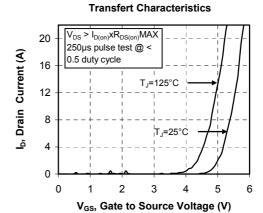


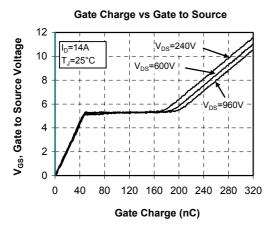


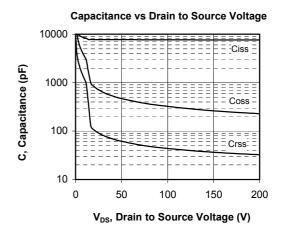








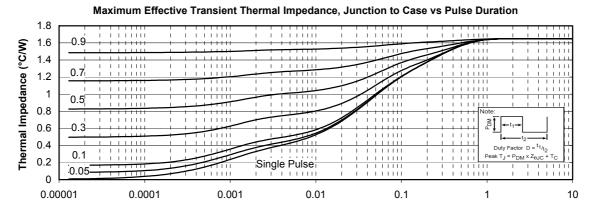




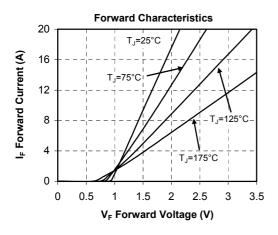
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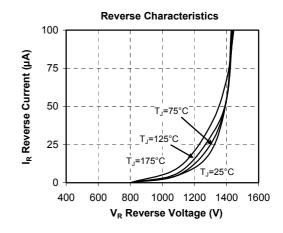


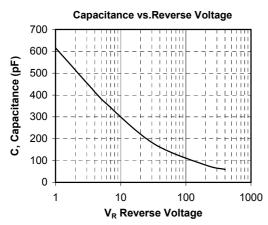
Typical SiC Diode Performance Curve



Rectangular Pulse Duration (Seconds)







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